imall

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

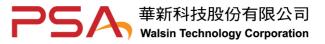
We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832 Email & Skype: info@chipsmall.com Web: www.chipsmall.com Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China







RFBPF Series – 1608(0603)- RoHS Compliance

MULTILAYER CERAMIC BAND PASS FILTER

Halogens Free Product

2.4 GHz ISM Band Working Frequency

P/N: RFBPF1608060ABT

*Contents in this sheet are subject to change without prior notice.

Approval sheet

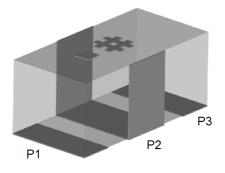
FEATURES

- 1. Miniature footprint: 1.6 X 0.8 X 0.6 mm³
- 2. Low Profile Thickness
- 3. Low Insertion loss
- 4. High Rejection Rate
- 5. High attenuation on 2nd harmonic suppressed
- 6. LTCC process

APPLICATIONS

- 1. 2.4GHz ISM band RF applications
- 2. Bluetooth, Wireless LAN 802.11b/g, HomeRF

CONSTRUCTION



PIN	Connection	
1	Input port	
2	GND	
3	Output port	

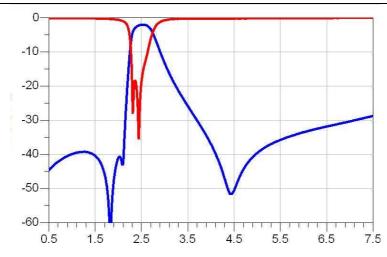
DIMENSIONS

Figure	Symbol	Dimension (mm)
	L	1.60 ± 0.15
= ##	W	0.80 ± 0.15
	т	0.60 ± 0.10
	А	0.55 ± 0.15
	В	0.50 ± 0.15
	С	0.35 ± 0.15
	D	0.50 ± 0.15
	E	0.20 ± 0.15

ELECTRICAL CHARACTERISTICS

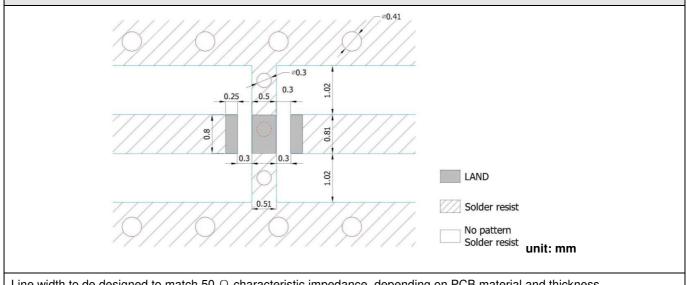
RFBPF1608060ABT	Specification
Frequency range	2450 ± 50 MHz
Insertion Loss	2.5 dB max at +25°C
Insertion Loss	2.8 dB max at -40°C ~ +85°C
VSWR	2.0 max
Impedance	50 Ω
	38 dB @ 880 - 915 MHz
	40 dB @ 1710 - 1850 MHz
	40 dB @ 1850 - 1910 MHz
Attenuation (min.)	35 dB @ 1920 - 1990 MHz
	25 dB @ 2170 MHz
	30 dB @ 4800 - 5000 MHz
	20 dB @ 7200 - 7500 MHz
Operation Temperature Range	-40°C ~ +85°C

Typical Electrical Chart

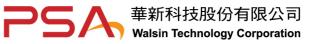


SOLDER LAND PATTERN

SOLDER LAND PATTERN



Line width to de designed to match 50 Ω characteristic impedance, depending on PCB material and thickness. D1 and D2 are the grounding through holes.



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RELIABILITY TEST

Test item Test condition / Test method		Specification		
Solderability JIS C 0050-4.6	*Solder bath temperature : $235 \pm 5^{\circ}$ C	At least 95% of a surface of each terminal		
JESD22-B102D	*Immersion time : 2 ± 0.5 sec	electrode must be covered by fresh solder.		
	Solder : Sn3Ag0.5Cu for lead-free			
Leaching (Resistance to dissolution	*Solder bath temperature : $260 \pm 5^{\circ}$ C	Loss of metallization on the edges of each electrode shall not exceed 25%.		
of metallization) IEC 60068-2-58	*Leaching immersion time : 30 ± 0.5 sec Solder : SN63A	electrode shall not exceed 25%.		
Resistance to soldering heat JIS C 0050-5.4	*Preheating temperature : 120~150°C,	No mechanical damage.		
	1 minute.	Samples shall satisfy electrical specification after test.		
	*Solder temperature : 270±5°C *Immersion time : 10±1 sec	Loss of metallization on the edges of each		
	Solder : Sn3Ag0.5Cu for lead-free	electrode shall not exceed 25%.		
	Measurement to be made after keeping at room temperature for 24±2 hrs			
Drop Test JIS C 0044 Customer's specification.	*Height : 75 cm *Test Surface : Rigid surface of concrete or steel.	No mechanical damage. Samples shall satisfy electrical specification after test.		
	*Times : 6 surfaces for each units ; 2 times for each side.			
Adhesive Strength of Termination JIS C 0051- 7.4.3	*Pressurizing force: 5N(≦0603);10N(>0603) *Test time:10±1 sec	No remarkable damage or removal of the termination.		
Bending test JIS C 0051- 7.4.1	The middle part of substrate shall be pressurized by means of the pressurizing rod at a rate of about 1 mm/s per second	No mechanical damage. Samples shall satisfy electrical specification after test.		
	until the deflection becomes 1mm/s and then pressure shall be maintained for 5±1 sec.			
	Measurement to be made after keeping at room temperature for 24±2 hours			

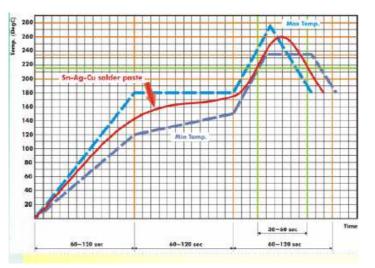
PSA 華新科技股份有限公司 Walsin Technology Corporation

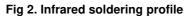
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Temperature cycle	1. 30±3 minutes at -40°C±3°C,	No mechanical damage.
JIS C 0025	2. 10~15 minutes at room temperature,	Samples shall satisfy electrical
	3. 30±3 minutes at +85°C±3°C,	specification after test.
	4. 10~15 minutes at room temperature,	
	Total 100 continuous cycles	
	Measurement to be made after keeping at	
	room temperature for 24±2 hrs	
Vibration	*Frequency : 10Hz~55Hz~10Hz(1min)	No mechanical damage.
JIS C 0040	*Total amplitude : 1.5mm	Samples shall satisfy electrical specification
	*Test times : 6hrs.(Two hrs each in three	after test.
	mutually perpendicular directions)	
High temperature JIS C 0021	*Temperature : 85°C±2°C	No mechanical damage.
	*Test duration : 1000+24/-0 hours	Samples shall satisfy electrical specification
	Measurement to be made after keeping at	after test.
	room temperature for 24±2 hrs	
Humidity	*Humidity : 90% to 95% R.H.	No mechanical damage.
(steady conditions)	*Temperature : 40±2°C	Samples shall satisfy electrical specification
JIS C 0022	*Time:1000+24/-0 hrs.	after test.
	Measurement to be made after keeping at	
	room temperature for 24±2 hrs	
	% 500hrs measuring the first data then	
	1000hrs data	
Low temperature	*Temperature : -40°C±2°C	No mechanical damage.
JIS C 0020	*Test duration : 1000+24/-0 hours	Samples shall satisfy electrical specification
	Measurement to be made after keeping at	after test.
	room temperature for 24±2 hrs	
L		

SOLDERING CONDITION

Typical examples of soldering processes that provide reliable joints without any damage are given in Fig 2,



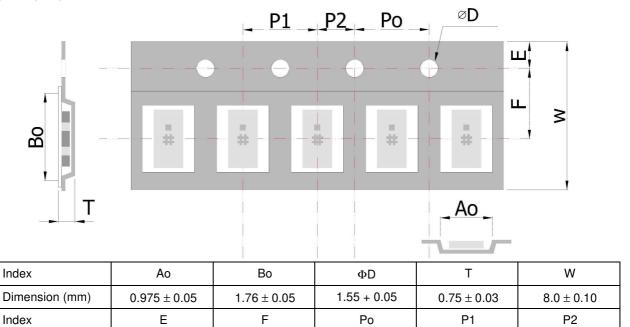


ORDERING CODE

RF	BPF	160806	0	Α	В	Т
Walsin	Product Code	Dimension code	Unit of	Application	Specification	Packing
RF device	BPF :	Per 2 digits of	dimension	A : 2.4GHZ ISM	dependent on	T : Reeled
	Band Pass Filter	Length, Width,	0 :0.1 mm	Band	different electrical	
		Thickness :	1 : 1.0 mm		specification	
		e.g. :				
		160806 =				
		Length 16,				
		Width 08,				
		Thickness06				

Minimum Ordering Quantity: 4000 pcs per reel. PACKAGING

Paper Tape specifications (unit :mm)



Dimension (mm)

 1.75 ± 0.10

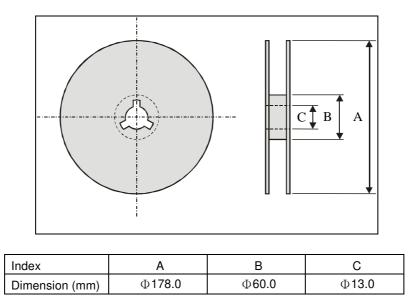
 4.00 ± 0.10

 3.50 ± 0.05

 2.00 ± 0.05

 4.00 ± 0.10

Reel dimensions



Taping Quantity: 4000 pieces per 7" reel

CAUTION OF HANDLING

Limitation of Applications

Please contact us before using our products for the applications listed below which require especially high reliability for the prevention of defects, which might directly cause damage to the third party's life, body or property.

- (1) Aircraft equipment
- (2) Aerospace equipment
- (3) Undersea equipment
- (4) Medical equipment
- (5) Disaster prevention / crime prevention equipment
- (6) Traffic signal equipment
- (7) Transportation equipment (vehicles, trains, ships, etc.)
- (8) Applications of similar complexity and /or reliability requirements to the applications listed in the above.

Storage condition

- (1) Products should be used in 6 months from the day of WALSIN outgoing inspection, which can be confirmed.
- (2) Storage environment condition.
 - Products should be storage in the warehouse on the following conditions.
 - Temperature : -10 to +40°C
 - Humidity : 30 to 70% relative humidity
 - Don't keep products in corrosive gases such as sulfur. Chlorine gas or acid or it may cause oxidization of electrode, resulting in poor solderability.
 - Products should be storage on the palette for the prevention of the influence from humidity, dust and son on.
 - Products should be storage in the warehouse without heat shock, vibration, direct sunlight and so on.
 - Products should be storage under the airtight packaged condition.